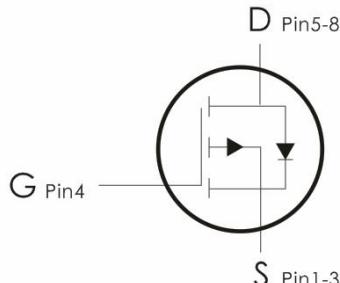
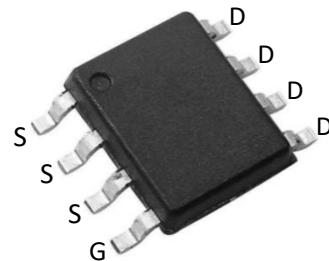


## 60V P-Channel MOSFET

**Description:**

This P-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.

**Features:**

- 1)  $V_{DS}=-60V, I_D=-8.5A, R_{DS(on)}<30m\Omega @ V_{GS}=-10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low  $R_{DS(on)}$ .
- 5) Excellent package for good heat dissipation.

**Absolute Maximum Ratings:** ( $T_C=25^\circ C$  unless otherwise noted)

<b>Symbol</b>	<b>Parameter</b>	<b>Ratings</b>	<b>Units</b>
$V_{DS}$	Drain-Source Voltage	-60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current- $T_C=25^\circ C$	-8.5	A
	Continuous Drain Current- $T_C=100^\circ C$	-5.4	
$I_{DM}$	Drain Current-Pulsed <sup>1</sup>	-34	A
$E_{AS}$	Single Pulse Avalanche Energy <sup>2</sup>	105	mJ
$I_{AS}$	Single Pulse Avalanche Current <sup>2</sup>	-46	A
$P_D$	Power Dissipation	4.1	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

**Thermal Characteristics:**

<b>Symbol</b>	<b>Parameter</b>	<b>Max</b>	<b>Units</b>
$R_{Theta A}$	Thermal Resistance,Junction to Ambient	62	$^\circ C / W$
$R_{Theta C}$	Thermal Resistance Junction to Case	30	$^\circ C / W$

**Electrical Characteristics:** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

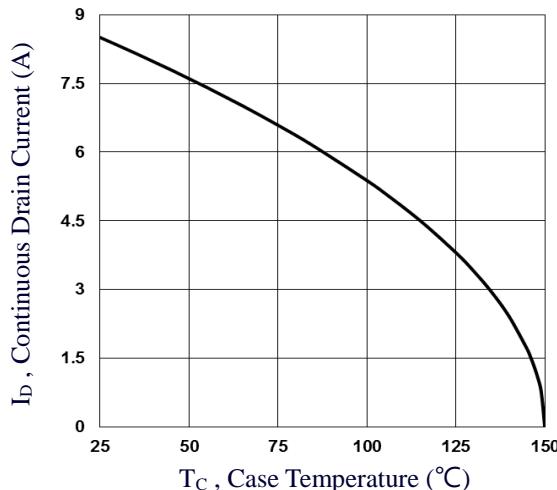
Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_D=250\ \mu\text{A}$	-60	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-60\text{V}, T_J=25^\circ\text{C}$	---	---	-1	$\mu\text{A}$
		$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-48\text{V}, T_J=125^\circ\text{C}$	---	---	-10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS(th)}}$	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_D=250\ \mu\text{A}$	-1	-1.6	-2.5	V
$R_{\text{DS(ON)}}$	Drain-Source On Resistance	$V_{\text{GS}}=-10\text{V}, I_D=-8\text{A}$	---	23	30	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_D=-6\text{A}$	---	28	40	
$G_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}, I_D=-3\text{A}$	---	18	---	S
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	2550	3850	pF
$C_{\text{oss}}$	Output Capacitance		---	160	230	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	110	165	
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-On Delay Time <sup>3,4</sup>	$V_{\text{DD}}=-30\text{V}, V_{\text{GS}}=-10\text{V}$ $I_D=-1\text{A}, R_{\text{GEN}}=6\ \Omega$	---	25	50	ns
$t_r$	Rise Time <sup>3,4</sup>		---	13.8	28	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time <sup>3,4</sup>		---	148	290	ns
$t_f$	Fall Time <sup>3,4</sup>		---	51	100	ns
$Q_g$	Total Gate Charge <sup>3,4</sup>		---	43.8	88	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>3,4</sup>	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=-10\text{V}, I_D=-5\text{A}$	---	4.6	9	nC
$Q_{\text{gd}}$	Gate-Drain "Miller" Charge <sup>3,4</sup>		---	8.3	17	nC
<b>Drain-Source Diode Characteristics</b>						

$I_S$	Continuous Source Current	$V_G=V_D=0V$ , Force Current	---	---	-8.5	A
$I_{SM}$	Pulsed Source Current		---	---	-17	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=-1A, T_J=25^{\circ}C$	---	---	-1	V
$t_{rr}$	Reverse Recovery Time	$V_R=-50V, I_S=-5A$	---	40	---	ns
			$dI/dt=100A/\mu s, T_J=25^{\circ}C$	---	30	---
$Q_{rr}$	Reverse Recovery Charge					nC

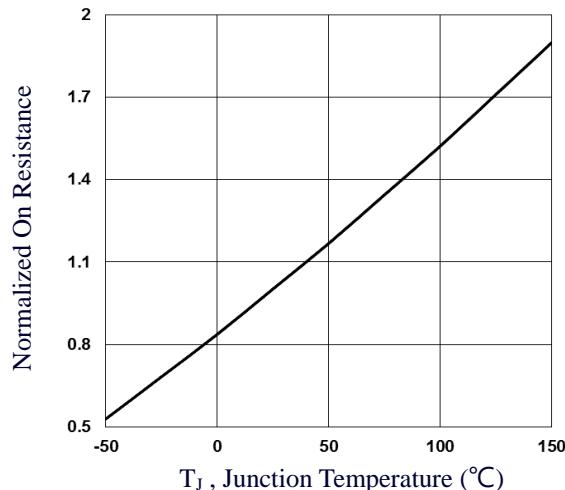
### Notes:

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-46A, R_g=25\Omega$ , Starting  $T_J=25^{\circ}C$ .
- The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
- Essentially independent of operating temperature.

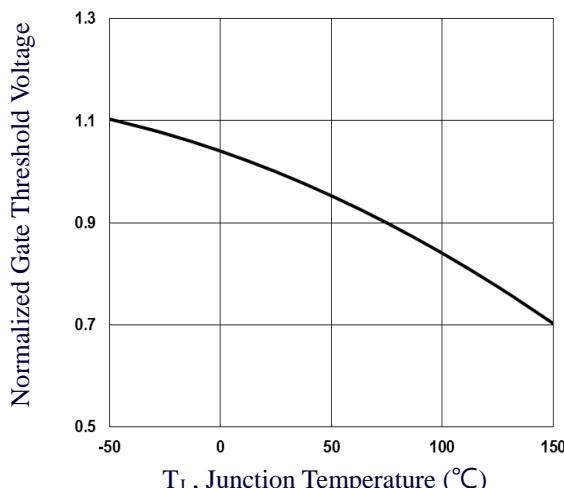
**Typical Characteristics:** ( $T_c=25^{\circ}C$  unless otherwise noted)



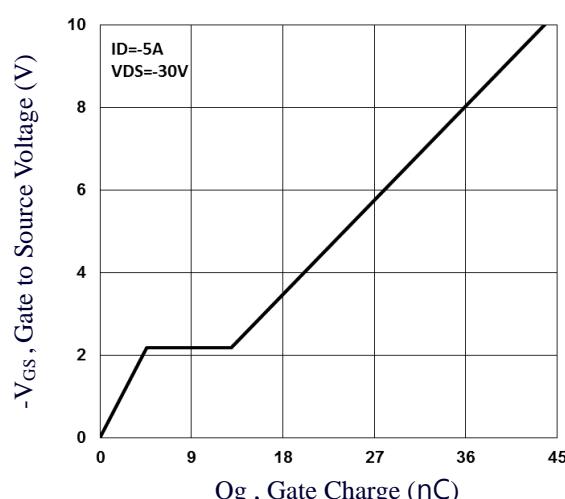
**Fig.1 Continuous Drain Current vs. Tc**



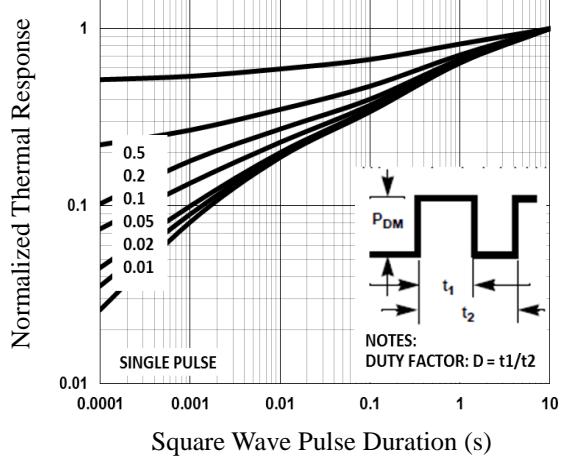
**Fig.2 Normalized RDSON vs. TJ**



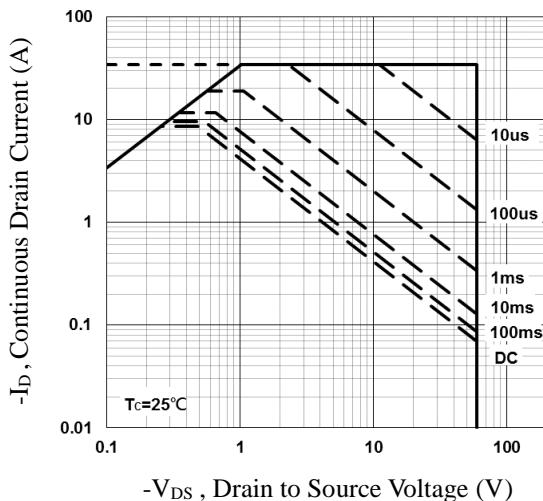
**Fig.3 Normalized V<sub>th</sub> vs. TJ**



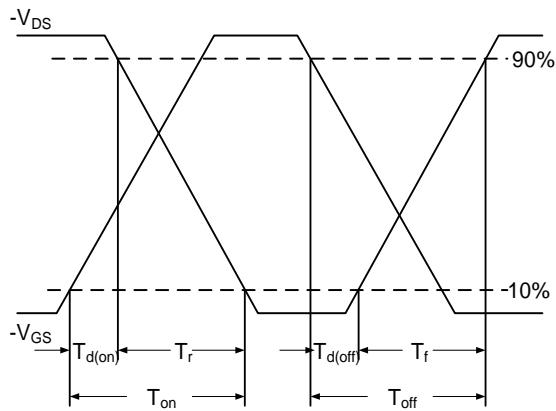
**Fig.4 Gate Charge Waveform**



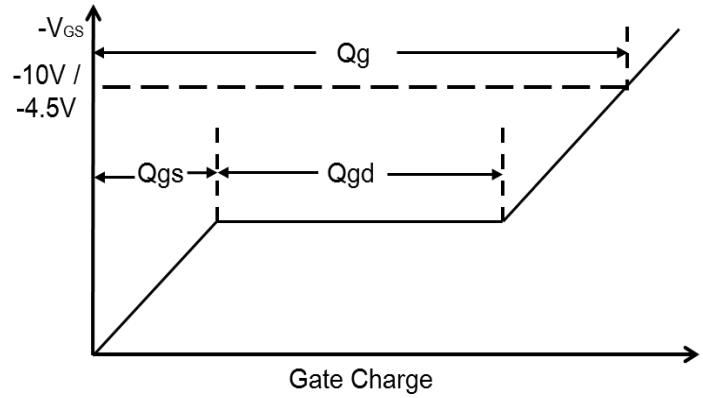
**Fig.5 Normalized Transient Impedance**



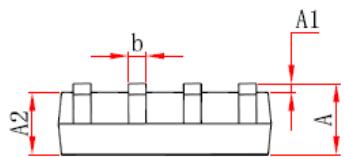
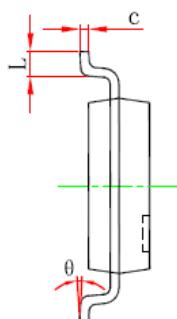
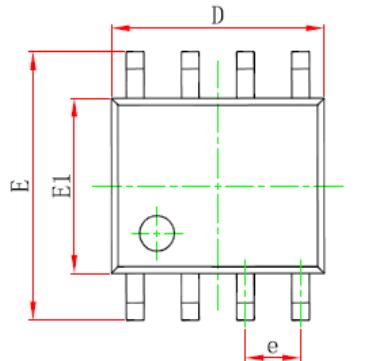
**Fig.6 Maximum Safe Operation Area**



**Fig.7 Switching Time Waveform**



**Fig.8 Gate Charge Waveform**

**SOP-8 Package information**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.450	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°